#### Addendum and Corrigendum-3

RFP for Selection of System Integrator for Implementation of Enterprise Resource Planning System





# Surat Smart City Development Limited ADDENDUM AND CORRIGENDUM-3

RFP No.: SSCDL-ERP-RFP-01-2017

The Bidders are requested to take note of the following changes made in the RFP document, which are to be taken in to account while submitting the RFP. They shall be presumed to have done so and submitted the RFP accordingly.

- This Addendum and Corrigendum shall be the part of the RFP documents.
- Content specified in this Addendum and Corrigendum supersede relevant content to that effect as provided in the original RFP documents. All other specifications, terms and conditions of the original RFP document shall remain unchanged.
- The queries raised and given by bidders, but the clarifications are not made in this Addendum and Corrigendum shall be considered to remain unchanged as per the terms and conditions mentioned in the original RFP documents.
- Bidders shall read and consider following points, which shall be a part of the RFP documents.

Highlighted Colour	What does it indicate?
No highlight	Indicates content as per original RFP document
Highlighted in Blue	Indicates amendment as per this Addendum and Corrigendum-3

#### Addendum and Corrigendum-3

RFP for Selection of System Integrator for Implementation of Enterprise Resource Planning System





#### I. Changes with respect to RFP Schedule

Please note that with respect to tendering schedules, the following changes have been effected. Bidders are requested to take note of the same and adhere to the dates specified hereunder with regards to Price Bid Submission and Technical Bid Submission:

Particular	<b>Current Dates</b>	Proposed Dates
Price Bid Submission	To be submitted online only on https://smc.nprocure.com on or before 03.07.2017 up to 18:00 hrs.	To be submitted online only on https://smc.nprocure.com on or before 17.07.2017 up to 18:00 hrs.
Technical Bid Submission (in Hard Copy) filled-in Technical Bid along with Bid Fee, EMD, Solvency Certificate and other documents.	In sealed envelope strictly by RPAD/Postal Speed Post on or before 06.07.2017 up to 18:00 hrs. to the Chief Accounts, Surat Municipal Corporation, Muglisara, Surat – 395003	In sealed envelope strictly by RPAD/Postal Speed Post on or before 19.07.2017 up to 18:00 hrs. to the Chief Accounts, Surat Municipal Corporation, Muglisara, Surat – 395003

## Addendum and Corrigendum-3

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### **II. Other Changes**

Tender	Existing Clause	Amended / New Clause
	b) The Technical Proposal shall be sealed separately in an envelope	c) The Technical Proposal shall be sealed separately in an envelope
5.4.1	on which the following shall be super scribed:	on which the following shall be super scribed:
Check list	"Envelope 2 – Technical Proposal for RFP No.: "SSCDL-	"Envelope 2 – Technical Proposal for RFP No.: "SSCDL-
for	ERP-RFP-01-2017"	ERP-RFP-01-2017"
	The bidder shall submit all the relevant documents so as to	The bidder shall submit all the relevant documents so as to
	ascertain the claims made. Following is the indicative list of	ascertain the claims made. Following is the indicative list of
·	documents that are to be submitted. The documents of	documents that are to be submitted. The documents of
Page 98	Technical Proposal shall be as per the Appendix 1 of this RFP	Technical Proposal shall be as per the Appendix 1 of this RFP
	and should comprise of all documents required to be submitted	and should comprise of all documents required to be submitted
	as per the said Appendix 1. All the pages submitted should have	as per the said Appendix 1. All the pages submitted should have
	page numbers along with an index or content page for easy	page numbers along with an index or content page for easy
	reference. The technical proposal in envelope 2 should not have	reference. The technical proposal in envelope 2 should not have
	loose papers and must bind logically together. The checklist of	loose papers and must bind logically together. The Bidder shall
	Technical Proposal presented below:	prepare original set of the Application (together with originals
		/copies of documents required to be submitted along therewith
		pursuant to this document) and applicant shall also provide a
		soft copy on a Compact Disc (CD) / Pen Drive / USB stick. In the
		event of any discrepancy between the original and CD/Pen
		Drive/USB stick, the original shall prevail. The checklist of
		Technical Proposal presented below:
	Reference Section – 5.4.1 Check list	Section – 5.4.1  Check list for documents - Technical Proposal shall be sealed separately in an envelope an which the following shall be super scribed:  "Envelope 2 – Technical Proposal for RFP No.: "SSCDL-ERP-RFP-01-2017"  The bidder shall submit all the relevant documents so as to ascertain the claims made. Following is the indicative list of documents that are to be submitted. The documents of Technical Proposal shall be as per the Appendix 1 of this RFP and should comprise of all documents required to be submitted as per the said Appendix 1. All the pages submitted should have page numbers along with an index or content page for easy reference. The technical proposal in envelope 2 should not have loose papers and must bind logically together. The checklist of

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